Electronic Patent A	/bb	lication Fe	e Transm	ittal		
Application Number:	10576639					
Filing Date:						
Title of Invention:	Method for Gluing a Circuit Component to a Circuit Substrate					
First Named Inventor/Applicant Name:	Willbald Konrath					
Filer:	Stephen A. Herrera/Laura Wade					
Attorney Docket Number:	5577-006					
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